

# Reference Design Guide

## Auxiliary Water Pump 100W

### Design overview

This Infineon Reference Design Guide describes a detailed implementation of an automotive auxiliary water pump using the 3-phase motor driver TLE9879 of the Embedded Power ICs family as BLDC motor controller. The three half-bridge MOSFET in a SSO8 package are used to control an auxiliary water pump with sensor less FOC.

The design is capable to drive loads up to 100W at a battery voltage of 12 V.

This design guide contains a description of the design, schematics and measurement reports.

EMC is tested according to the CISPR25 standard. Thermal performance information is given and discussed.

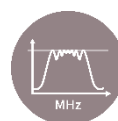
### Highlighted Components

- TLE9879QXW40
- IAUC60N04S6N031H
- IPZ40N04S5-3R1

### Applications

- Auxiliary water pump
- Oil pump
- 100W BLDC Motor for 12 V applications

### Highlighted Design Aspects



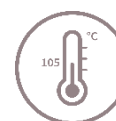
EMC  
optimized



Cost  
optimized

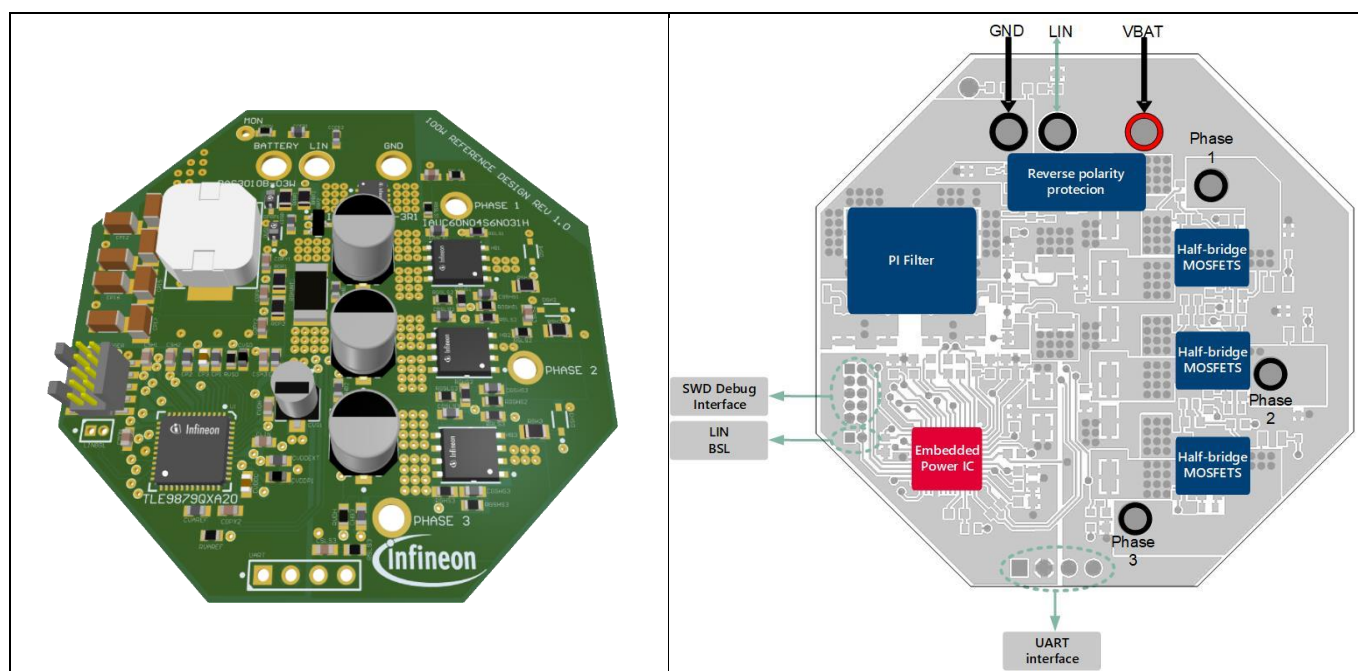


Space  
optimized



Thermally  
optimized

### Reference Design and Block Diagram



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## 1 System description

The reference design describes a solution for an auxiliary water pump. This solution can be used for similar applications with smaller or equal power consumption. The circuit contains an integrated 3-phase motor control solution. The SoC microcontroller (TLE9879QXW40) is a member of the Embedded Power IC family. It combines an Arm® Cortex®-M3 microcontroller with application specific modules like an integrated 3-phase MOSFET driver, power supply and LIN-transceiver. In combination with the OptiMOS™-6 SSO8 half-bridge MOSFETs the system is optimized for a minimum of PCB size for this power class. The focus of the reference design is to use standard PCB materials and processes.

### 1.1 Design specifications

The design specifications are related to the used components and design considerations. They shouldn't differ from the product datasheet values. In case of misalignment, the datasheet values of the products are valid.

Parameter	Symbol	Values			Unit	Comment
		Min.	Typ.	Max.		
System Parameters						
Input voltage	V <sub>IN</sub>	-0.3	12	40	V	P_1.1.1 (TLE9879QXW40)
Functional input voltage	V <sub>IN</sub>	7	12	18	V	Specified according to water-pump specification
Peak input current	I <sub>IN</sub>	-	-	13.5	A	Peak current (<10 s)
Nominal input current	I <sub>IN</sub>	-	5	10	A	Specified for design
LIN interface	V <sub>LIN</sub>	-28	12	40	V	P_1.1.7 (TLE9879QXW40)
Phase 1,2,3	V <sub>SH</sub>	-8	12	48	V	P_1.1.11 (TLE9879QXW40)
Thermal						
Operating temperature	T <sub>A</sub>	-40	25	120	°C	Specified for Design
Electromagnetic Compatibility						
Conducted emissions				Class 5		CISPR25, 150 kHz -108 MHz
Mechanical Specification						
Dimensions PCB	55 mm x 55 mm x 10 mm (W x D x H)					
PCB + pump	118 mm x 74 mm x 140 mm (W x D x H)					



Figure 1 PCB in pump housing

## 1.2 Overview

0 shows the 3D CAD view of the system. The FR4 4 layer board has three SS08 half-bridge MOSFETs, one TSDSON-8 MOSFET for active reverse polarity protection, one 3-phase gate driver, and one shunt resistor. All active components, including the MOSFETs and one driver IC, are carefully located on the board to distribute the heat over the whole area of the PCB. As passive components, the shunt resistor is an additional heat source. It collects all return current from three legs of the bridge. As the PCB does only have surface-mounted components, it is possible to be directly connected to the pumps housing for optimized cooling.

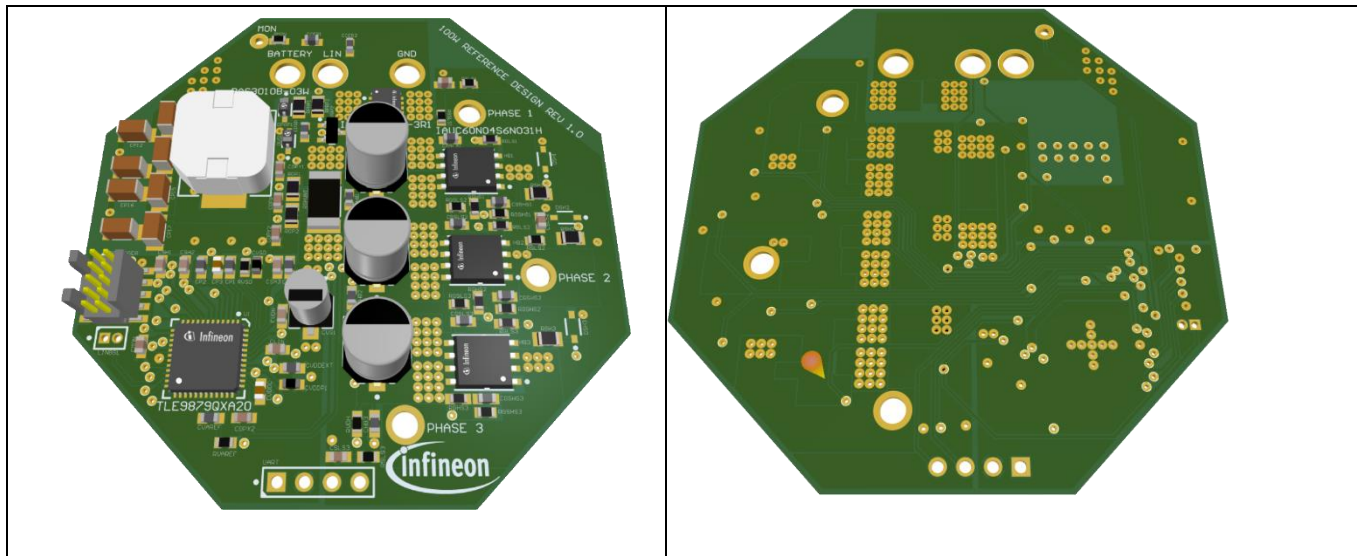


Figure 2 View of the reference design from top and bottom

## 1.3 Highlighted products

### 1.3.1 OptiMOS-6™ 40 V SS08 (PG-TDSON-8) MOSFET

The SS08 package offers high current capability of 60 A with a footprint of 5x6 mm<sup>2</sup>. In combination with Infineon's leading OptiMOS-6™ 40 V power MOS technology, SS08 offers optimized layout for B6 applications and cost efficiency at Infineon's well known quality level for robust automotive packages. For more information about the product, please visit the Infineon web-page linked below.

- [www.infineon.com/IAUC60N04S6N31H](http://www.infineon.com/IAUC60N04S6N31H)

Table 1 Automotive SS08 MOSFET with 40 V OptiMOS-6™

Package	Silicon Technology	Product	Max $R_{DS(on)}$ [mΩ]	ID [A]	QG [nC]
SS08 (TDSON-8)	OptiMOS™-6	IAUC60N04S6L030H	3.0	60	27
		IAUC60N04S6N031H	3.1	60	23
		IAUC60N04S6L045H	4.5	60	14
		IAUC60N04S6N050H	5.0	60	13
		IAUC45N04S6L063H	6.3	45	10
		IAUC45N04S6N070H	7.0	45	9



### 1.3.2 3-Phase bridge driver IC with integrated arm® Cortex®-M3

The TLE987x family addresses a wide range of smart 3-phase brushless DC motor control applications such as auxiliary pumps and fans. It provides an unmatched level of integration and system cost to optimize the target application segments. In addition, it offers scalability in terms of flash memory sizes and MCU system clock frequency supporting a wide range of motor control algorithms, either sensor-based or sensor-less. For more information about the product, please visit Infineon web-page linked below.

- [www.infineon.com/tle987x](http://www.infineon.com/tle987x)

**Table 2 Product Family of 3-Phase Bridge Driver IC with Integrated Arm® Cortex®-M3**

Grade	Product	Flash	RAM	Frequency	Interface	Tjmax
Grade-0	TLE9873QXW40	48 kByte	3 kByte	40 MHz	PWM + LIN	175 °C
	TLE9877QXW40	64 kByte	6 kByte	40 MHz	PWM + LIN	175 °C
	TLE9879QX40W	128 kByte	6 kByte	40 MHz	PWM + LIN	175 °C
Grade-1	TLE9871QXA20	36 kByte	3 kByte	24 MHz	PWM	150 °C
	TLE9877QXA20	64 kByte	6 kByte	24 MHz	PWM + LIN	150 °C
	TLE9877QXA40	64 kByte	6 kByte	40 MHz	PWM + LIN	150 °C
	TLE9879-2QXA40	128 kByte	6 kByte	40 MHz	PWM + LIN	150 °C
	TLE9879QXA40	128 kByte	6 kByte	40 MHz	PWM + LIN	150 °C

### 1.3.3 OptiMOS-5™ 40 V S308 (PG-TDSON-8) MOSFET

The S308 package offers high current capability of 40 A with a footprint of 3.3x3.3 mm<sup>2</sup>. In combination with Infineon's leading OptiMOS-5™ 40 V power MOS technology, they are optimized to meet and exceed the energy efficiency and power density requirements of automotive BLDC and H-bridge applications. In combination with Infineon's robust S308 leadless package technology, it enables very small and efficient systems designs with minimal RDS(on) down to 2.8 mΩ. For more information about the product, please visit the Infineon web-page linked below.

- [www.infineon.com/optimos5-40v60v](http://www.infineon.com/optimos5-40v60v)

**Table 3 Automotive S308 MOSFET with 40 V OptiMOS-5™**

Package	Silicon Technology	Product	Max R <sub>DS(on)</sub> [mΩ]	ID [A]
S308 (PG-TDSON-8)	OptiMOS™-5	IPZ40N04S5L-2R8	2.8	40
		IPZ40N04S5-3R1	3.1	40
		IPZ40N04S5L-4R8	4.8	40
		IPZ40N04S5-5R4	5.4	40
		IPZ40N04S5L-7R4	7.4	40
		IPZ40N04S5-8R4	8.4	40

## 2 Toolchain installation

In order to get the board ready and running, the software shown in Table 4 shall be installed.

The  $\mu$ Vision software is a development tool provided by arm® Keil®. With code length limitation, the shareware version of the  $\mu$ Vision is still able to edit, compile and debug. The Infineon Config Wizard is a tool for configuring peripherals of the Embedded Power IC. The tool can be called from the pull-down menu of the  $\mu$ Vision and helps users changing parameters from its user interface and then generates the software code accordingly. Infineon provides standard motor drive software codes for the Embedded Power IC. It can be downloaded from the Pack Installer within the  $\mu$ Vision.

**Table 4 Software Toolchain Installation Guide**

Steps	Company	Description
<b>STEP1</b> Download and Install <a href="#">Keil® <math>\mu</math>Vision5</a>	Arm® Keil®	<ul style="list-style-type: none"> <li>Arm® Keil® <math>\mu</math>Vision is an integrated development environment which consists of code editor, compiler and debugger.</li> <li>To learn how to use arm® Keil® <math>\mu</math>Vision 5, check out our video "<a href="#">Get your motor spinning</a>".</li> </ul>
<b>STEP2</b> Download Config Wizard	Infineon Technologies	<ul style="list-style-type: none"> <li>Infineon provides the Config Wizard free of charge, which is designed for configuration of chip modules. Config Wizard supports easy configuring of Embedded Power IC peripherals.</li> <li>Config Wizard can be installed via the Infineon Toolbox. If you don't have the Infineon Toolbox yet, please go to <a href="#">Infineon Toolbox</a> and enjoy the release management for updates.</li> </ul>
<b>STEP3</b> Download and Install <a href="#">Segger J-Link Driver</a>	SEGGER	<ul style="list-style-type: none"> <li>SEGGER J-Link is a widely used driver for "on-board" or "stand-alone" debugger.</li> </ul>
<b>STEP4</b> Download the SDK via $\mu$ Vision5 Pack Installer	Infineon Technologies	<ul style="list-style-type: none"> <li>The Embedded Power Software Development Kit (SDK) is a low level driver library which can be downloaded within Keil® <math>\mu</math>Vision via the "Pack Installer"</li> </ul>

For the toolchain installation and free motor drive software, please check below link.

[www.infineon.com/embedded-power](http://www.infineon.com/embedded-power)

For more information about the tool chain installation steps, watch our video.

[Toolchain Installation for Embedded Power ICs / TLE98xx](#)

### 2.1.1 Configuration

Open a motor drive code project in  $\mu$ Vision5 and go to "Tools" and open "Config Wizard". From there, setup the parameters of motor, speed/current controller and the peripherals of TLE987x. As the Embedded Power IC has a current-source gate driving scheme, the switching speed is not controlled by gate resistors, but by the "Gate Charge/Discharge" parameters in the BDRV tap of the peripherals. For more details about the configuration, please visit the Infineon website of Embedded Power ICs.



## 7 Abbreviations and definitions

**Table 11** Abbreviations

Abbreviation	Definition
LIN	Local Interconnect Network
FOC	Field Oriented Control
MI	Modulation Index
RBP	Reverse Battery Protection
PSI	Pound Force per Square Inch
ECU	Electrical Control Unit
PWM	Pulse Width Modulation
PCB	Printed Circuit Board
EMC	Electromagnetic Compatibility
IC	Integrated Circuit
DC	Direct Current
ESR	Equivalent Series Resistance
DUT	Device under test

## 8 Reference documents

This document should be read in conjunction with the following documents:

- [1] TLE9879QXA40 datasheet, Infineon Technologies AG, [https://www.infineon.com/dgdl/Infineon-TLE9879QXW40-DS-v01\\_01-EN.pdf?fileId=5546d4625b10283a015b248fc7622e4b](https://www.infineon.com/dgdl/Infineon-TLE9879QXW40-DS-v01_01-EN.pdf?fileId=5546d4625b10283a015b248fc7622e4b)
- [2] TLE986x\_TLE987x Bridge Driver Application Note, 2018-12, Infineon Technologies AG, Rev 1.02 [https://www.infineon.com/dgdl/Infineon-TLE987x\\_TLE986x-BDRV-ApplicationNotes-v01\\_02-EN.pdf?fileId=5546d46267c74c9a0167cbe1686a191d](https://www.infineon.com/dgdl/Infineon-TLE987x_TLE986x-BDRV-ApplicationNotes-v01_02-EN.pdf?fileId=5546d46267c74c9a0167cbe1686a191d)
- [3] IPZ40N04S5L-2R8 datasheet, Infineon Technologies AG, [https://www.infineon.com/dgdl/Infineon-IPZ40N04S5L-2R8-DS-v01\\_01-EN.pdf?fileId=5546d4624cb7f111014d6601139b4890](https://www.infineon.com/dgdl/Infineon-IPZ40N04S5L-2R8-DS-v01_01-EN.pdf?fileId=5546d4624cb7f111014d6601139b4890)
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- [5] Reverse Polarity Protection for Embedded Power ICs, 2018-12, Infineon Technologies AG, Rev 1.0 [https://www.infineon.com/dgdl/Infineon-Reverse\\_Polarity\\_Protection-AN-v01\\_00-EN.pdf?fileId=5546d46267c74c9a01684be08bf45dfb](https://www.infineon.com/dgdl/Infineon-Reverse_Polarity_Protection-AN-v01_00-EN.pdf?fileId=5546d46267c74c9a01684be08bf45dfb)
- [6] IPC-2152, 2003-05, Institute for Interconnecting and Packaging Electronic Circuits
- [7] IEC 60664-1, 2007-04, International Electrotechnical Commission

## Revision history

### Major changes since the last revision

Date	Version	Description
29.09.2020	V1.0	Initial version

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**Edition 2020-03-11**

**Published by**

**Infiniteon Technologies AG**

**81726 Munich, Germany**

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